



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(S): Hyun-Ki Kim et al.

SERIAL NO.: 10/662,675

EXAMINER: Unassigned

DATE FILED: September 15, 2003

ART UNIT: Unassigned

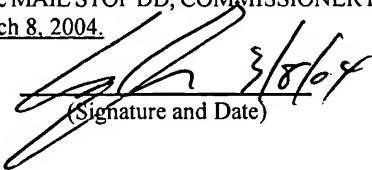
FOR: METHOD FOR FABRICATING OPTICAL FIBER BLOCK USING SILICON-GLASS ANODIC BONDING TECHNIQUE

CERTIFICATE OF MAILING UNDER 37 CFR §1.8

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Steve Cha, Reg. No. 44,069

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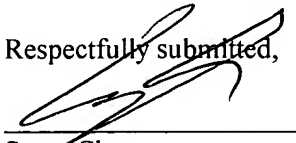
Sir:

INFORMATION DISCLOSURE STATEMENT

In accordance with Applicant's and Applicant's representatives' Duty of Disclosure under 37 CFR § 1.56, and pursuant to 37 CFR §1.97 and MPEP 717.05(b), Applicant(s) submit herewith documentary information for consideration by the Examiner. Information herein cited is only set forth in fulfillment of Applicant's duty of candor in disclosing all information brought to his attention, and is not an admission that it can be used adversely. The publications forwarded herewith are listed on the enclosed Form PTO-1449. Applicant(s) request that the Examiner, upon reviewing the enclosed materials, initial the enclosed form and return a copy thereof in accordance with the instructions on the form.

Enclosed please find copies of 3 U.S. Patents and 4 Publications listed on the attached Form PTO-1449. No fee is believed due for the filing of this statement inasmuch as it is being filed before the mailing of the first official action on the merits. However, should the Patent and Trademark Office determine otherwise, authorization is hereby given to charge Deposit Account No. 502-470 for this filing.

Respectfully submitted,



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Sheet 1 of 1

Form PTO-1449 IRSY. 7.801 U.S. Department of Commerce Patent and Trademark Office	ATTORNEY DOCKET NO.	5000-1-371
	SERIAL NO.	10/662,675
LIST OF DOCUMENTARY INFORMATION CITED BY APPLICANT (Use several sheets if necessary)	APPLICANT	Hyun-Ki Kim et al.
	FILING DATE	September 15, 2003
	GROUP	Unassigned

U.S. PATENT DOCUMENTS

EXAMINE R INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE IF APPROPRIATE
	AA	3,397,278	8/13/68	Pomerantz	174	52	
	AB	5,774,609	6/30/98	Bäcklin et al.	385	49	1/27/97
	AC	5,692,089	11/25/97	Sellers	385	137	4/11/96

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB- CLASS	TRANSLATION YES NO

OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)

	AD	Publication No. XP000355794; Yozo Kanda et al.; "The Mechanism of Field-Assisted Silicon-Glass Bonding;" April 1, 1990; 5 pages.
	AE	Publication No. XP004380164; Gabriel Blasquez et al.; "Silicon Glass Anodic Bonding Under Partial Vacuum Conditions: Problems and Solutions;" September 30, 2002; 4 pages.
	AF	Publication No. XP002267245; Hans L. Althaus et al.; "Microsystems and Wafer Processes for Volume Production of Highly Reliable Fiber Optic Components for Telecom- and Datacom-Application;" May 2, 1998; 10 pages.
	AG	Publication No. XP000601832; George Wallis et al.; "Field Assisted Glass-Metal Sealing;" September 1, 1969; 4 pages.
EXAMINER:		DATE CONSIDERED:
<p>*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</p>		